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What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

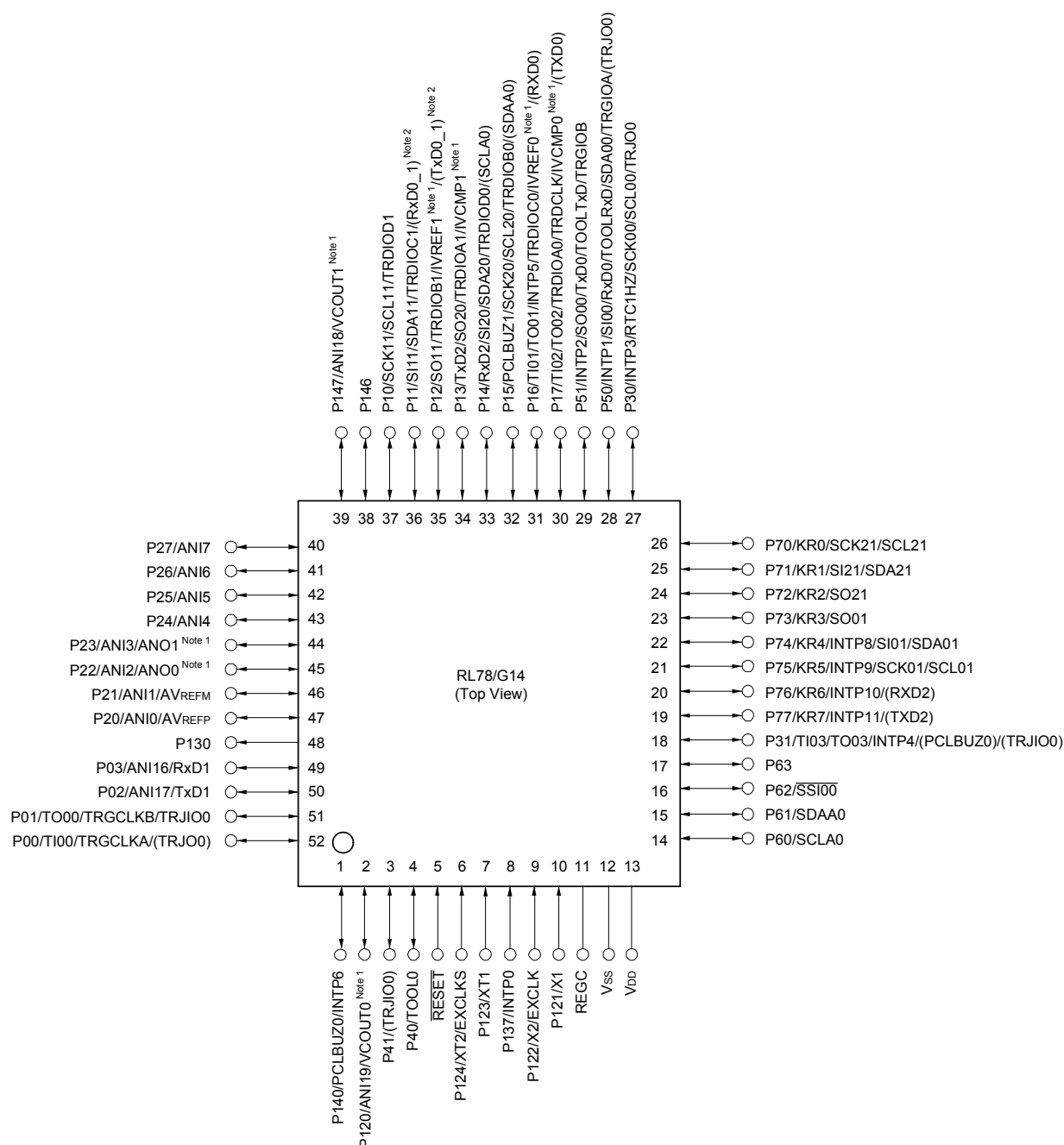
Applications of "[Embedded - Microcontrollers](#)"

Details

| | |
|----------------------------|---|
| Product Status | Obsolete |
| Core Processor | RL78 |
| Core Size | 16-Bit |
| Speed | 32MHz |
| Connectivity | CSI, I ² C, LINbus, UART/USART |
| Peripherals | DMA, LVD, POR, PWM, WDT |
| Number of I/O | 31 |
| Program Memory Size | 128KB (128K x 8) |
| Program Memory Type | FLASH |
| EEPROM Size | 8K x 8 |
| RAM Size | 16K x 8 |
| Voltage - Supply (Vcc/Vdd) | 1.6V ~ 5.5V |
| Data Converters | A/D 10x8/10b; D/A 2x8b |
| Oscillator Type | External, Internal |
| Operating Temperature | -40°C ~ 85°C (TA) |
| Mounting Type | Surface Mount |
| Package / Case | 44-LQFP |
| Supplier Device Package | 44-LQFP (10x10) |
| Purchase URL | https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f104fgafp-v0 |

1.3.7 52-pin products

- 52-pin plastic LQFP (10 × 10 mm, 0.65 mm pitch)



Note 1. Mounted on the 96 KB or more code flash memory products.

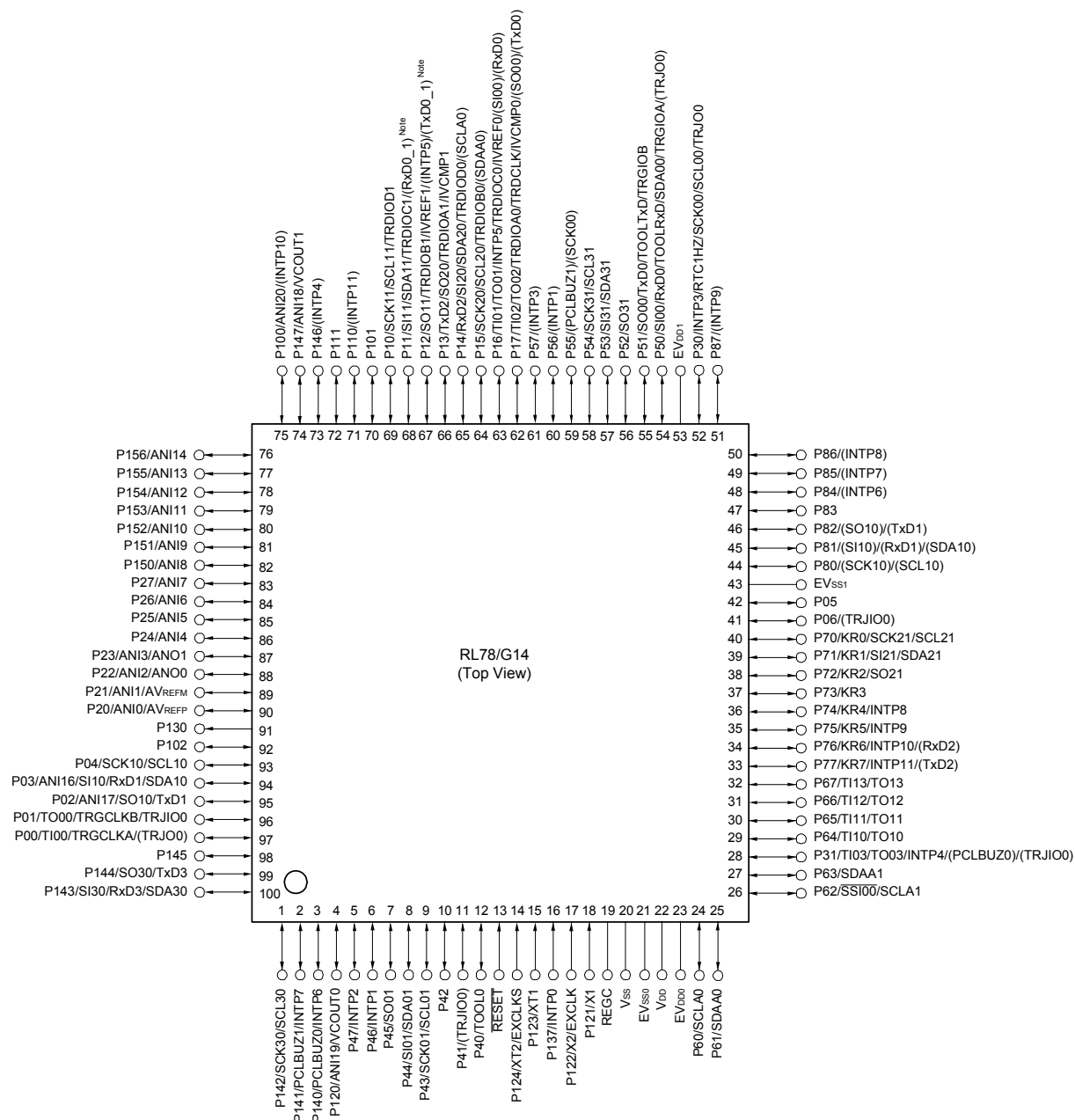
Caution Connect the REGC pin to V_{SS} pin via a capacitor (0.47 to 1 μF).

Remark 1. For pin identification, see 1.4 Pin Identification.

Remark 2. Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register 0, 1 (PIOR0, 1).

1.3.10 100-pin products

- 100-pin plastic LFQFP (14 × 14 mm, 0.5 mm pitch)



Note Mounted on the 384 KB or more code flash memory products.

Caution 1. Make EVss0, EVss1 pins the same potential as Vss pin.

Caution 2. Make VDD pin the potential that is higher than EVDD0, EVDD1 pins (EVDD0 = EVDD1).

Caution 3. Connect the REGC pin to Vss pin via a capacitor (0.47 to 1 μF).

Remark 1. For pin identification, see 1.4 Pin Identification.

Remark 2. When using the microcontroller for an application where the noise generated inside the microcontroller must be reduced, it is recommended to supply separate powers to the VDD, EVDD0 and EVDD1 pins and connect the Vss, EVss0 and EVss1 pins to separate ground lines.

Remark 3. Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register 0, 1 (PIOR0, 1).

1.6 Outline of Functions

[30-pin, 32-pin, 36-pin, 40-pin products (code flash memory 16 KB to 64 KB)]

Caution This outline describes the functions at the time when Peripheral I/O redirection register 0, 1 (PIOR0, 1) are set to 00H.

(1/2)

| Item | | 30-pin | 32-pin | 36-pin | 40-pin |
|------------------------------------|--|--|-----------------------------|-----------------------------|--|
| | | R5F104Ax (x = A, C to E) | R5F104Bx (x = A, C to E) | R5F104Cx (x = A, C to E) | R5F104Ex (x = A, C to E) |
| Code flash memory (KB) | | 16 to 64 | 16 to 64 | 16 to 64 | 16 to 64 |
| Data flash memory (KB) | | 4 | 4 | 4 | 4 |
| RAM (KB) | | 2.5 to 5.5 Note | 2.5 to 5.5 Note | 2.5 to 5.5 Note | 2.5 to 5.5 Note |
| Address space | | 1 MB | | | |
| Main system clock | High-speed system clock | X1 (crystal/ceramic) oscillation, external main system clock input (EXCLK) HS (high-speed main) mode: 1 to 20 MHz ($V_{DD} = 2.7$ to 5.5 V), HS (high-speed main) mode: 1 to 16 MHz ($V_{DD} = 2.4$ to 5.5 V), LS (low-speed main) mode: 1 to 8 MHz ($V_{DD} = 1.8$ to 5.5 V), LV (low-voltage main) mode: 1 to 4 MHz ($V_{DD} = 1.6$ to 5.5 V) | | | |
| | High-speed on-chip oscillator clock (f _{IH}) | HS (high-speed main) mode: 1 to 32 MHz ($V_{DD} = 2.7$ to 5.5 V), HS (high-speed main) mode: 1 to 16 MHz ($V_{DD} = 2.4$ to 5.5 V), LS (low-speed main) mode: 1 to 8 MHz ($V_{DD} = 1.8$ to 5.5 V), LV (low-voltage main) mode: 1 to 4 MHz ($V_{DD} = 1.6$ to 5.5 V) | | | |
| Subsystem clock | | — | | | XT1 (crystal) oscillation, external subsystem clock input (EXCLKS) 32.768 kHz |
| Low-speed on-chip oscillator clock | | 15 kHz (TYP.): $V_{DD} = 1.6$ to 5.5 V | | | |
| General-purpose register | | 8 bits × 32 registers (8 bits × 8 registers × 4 banks) | | | |
| Minimum instruction execution time | | 0.03125 μs (High-speed on-chip oscillator clock: f _{IH} = 32 MHz operation) | | | |
| | | 0.05 μs (High-speed system clock: f _{MX} = 20 MHz operation) | | | |
| | | — | | | 30.5 μs (Subsystem clock: f _{SUB} = 32.768 kHz operation) |
| Instruction set | | <ul style="list-style-type: none"> • Data transfer (8/16 bits) • Adder and subtractor/logical operation (8/16 bits) • Multiplication (8 bits × 8 bits, 16 bits × 16 bits), Division (16 bits ÷ 16 bits, 32 bits ÷ 32 bits) • Multiplication and Accumulation (16 bits × 16 bits + 32 bits) • Rotate, barrel shift, and bit manipulation (Set, reset, test, and Boolean operation), etc. | | | |
| I/O port | Total | 26 | 28 | 32 | 36 |
| | CMOS I/O | 21 | 22 | 26 | 28 |
| | CMOS input | 3 | 3 | 3 | 5 |
| | CMOS output | — | — | — | — |
| | N-ch open-drain I/O (6 V tolerance) | 2 | 3 | 3 | 3 |
| Timer | 16-bit timer | 8 channels (TAU: 4 channels, Timer RJ: 1 channel, Timer RD: 2 channels, Timer RG: 1 channel) | | | |
| | Watchdog timer | 1 channel | | | |
| | Real-time clock (RTC) | 1 channel | | | |
| | 12-bit interval timer | 1 channel | | | |
| | Timer output | Timer outputs: 13 channels PWM outputs: 9 channels | | | |
| | RTC output | — | | | 1 • 1 Hz (subsystem clock: f _{SUB} = 32.768 kHz) |

(Note is listed on the next page.)

Note The flash library uses RAM in self-programming and rewriting of the data flash memory.
The target products and start address of the RAM areas used by the flash library are shown below.
R5F104xD (x = A to C, E to G, J, L): Start address FE900H
R5F104xE (x = A to C, E to G, J, L): Start address FE900H
For the RAM areas used by the flash library, see **Self RAM list of Flash Self-Programming Library for RL78 Family (R20UT2944)**.

[48-pin, 64-pin products (code flash memory 384 KB to 512 KB)]

Caution This outline describes the functions at the time when Peripheral I/O redirection register 0, 1 (PIOR0, 1) are set to 00H.

(1/2)

| Item | | 48-pin | 64-pin |
|------------------------------------|--|--|------------------------|
| | | R5F104Gx (x = K, L) | R5F104Lx (x = K, L) |
| Code flash memory (KB) | | 384 to 512 | 384 to 512 |
| Data flash memory (KB) | | 8 | 8 |
| RAM (KB) | | 32 to 48 Note | 32 to 48 Note |
| Address space | | 1 MB | |
| Main system clock | High-speed system clock | X1 (crystal/ceramic) oscillation, external main system clock input (EXCLK) HS (high-speed main) mode: 1 to 20 MHz (V _{DD} = 2.7 to 5.5 V), HS (high-speed main) mode: 1 to 16 MHz (V _{DD} = 2.4 to 5.5 V), LS (low-speed main) mode: 1 to 8 MHz (V _{DD} = 1.8 to 5.5 V), LV (low-voltage main) mode: 1 to 4 MHz (V _{DD} = 1.6 to 5.5 V) | |
| | High-speed on-chip oscillator clock (f _{IH}) | HS (high-speed main) mode: 1 to 32 MHz (V _{DD} = 2.7 to 5.5 V), HS (high-speed main) mode: 1 to 16 MHz (V _{DD} = 2.4 to 5.5 V), LS (low-speed main) mode: 1 to 8 MHz (V _{DD} = 1.8 to 5.5 V), LV (low-voltage main) mode: 1 to 4 MHz (V _{DD} = 1.6 to 5.5 V) | |
| Subsystem clock | | XT1 (crystal) oscillation, external subsystem clock input (EXCLKS) 32.768 kHz | |
| Low-speed on-chip oscillator clock | | 15 kHz (TYP.): V _{DD} = 1.6 to 5.5 V | |
| General-purpose register | | 8 bits × 32 registers (8 bits × 8 registers × 4 banks) | |
| Minimum instruction execution time | | 0.03125 μs (High-speed on-chip oscillator clock: f _{IH} = 32 MHz operation) | |
| | | 0.05 μs (High-speed system clock: f _{MX} = 20 MHz operation) | |
| | | 30.5 μs (Subsystem clock: f _{SUB} = 32.768 kHz operation) | |
| Instruction set | | <ul style="list-style-type: none"> • Data transfer (8/16 bits) • Adder and subtractor/logical operation (8/16 bits) • Multiplication (8 bits × 8 bits, 16 bits × 16 bits), Division (16 bits ÷ 16 bits, 32 bits ÷ 32 bits) • Multiplication and Accumulation (16 bits × 16 bits + 32 bits) • Rotate, barrel shift, and bit manipulation (Set, reset, test, and Boolean operation), etc. | |
| I/O port | Total | 44 | 58 |
| | CMOS I/O | 34 | 48 |
| | CMOS input | 5 | 5 |
| | CMOS output | 1 | 1 |
| | N-ch open-drain I/O (6 V tolerance) | 4 | 4 |
| Timer | 16-bit timer | 8 channels (TAU: 4 channels, Timer RJ: 1 channel, Timer RD: 2 channels, Timer RG: 1 channel) | |
| | Watchdog timer | 1 channel | |
| | Real-time clock (RTC) | 1 channel | |
| | 12-bit interval timer | 1 channel | |
| | Timer output | Timer outputs: 14 channels PWM outputs: 9 channels | |
| | RTC output | 1 • 1 Hz (subsystem clock: f _{SUB} = 32.768 kHz) | |

(Note is listed on the next page.)

Note The flash library uses RAM in self-programming and rewriting of the data flash memory.
The target products and start address of the RAM areas used by the flash library are shown below.
R5F104xL (x = G, L, M, P): Start address F3F00H
For the RAM areas used by the flash library, see **Self RAM list of Flash Self-Programming Library for RL78 Family (R20UT2944)**.

(2/2)

| Item | | 80-pin | 100-pin |
|-----------------------------------|----------------------|--|------------------------|
| | | R5F104Mx (x = K, L) | R5F104Px (x = K, L) |
| Clock output/buzzer output | | 2 | 2 |
| | | <ul style="list-style-type: none"> • 2.44 kHz, 4.88 kHz, 9.76 kHz, 1.25 MHz, 2.5 MHz, 5 MHz, 10 MHz (Main system clock: f_{MAIN} = 20 MHz operation) • 256 Hz, 512 Hz, 1.024 kHz, 2.048 kHz, 4.096 kHz, 8.192 kHz, 16.384 kHz, 32.768 kHz (Subsystem clock: f_{SUB} = 32.768 kHz operation) | |
| 8/10-bit resolution A/D converter | | 17 channels | 20 channels |
| D/A converter | | 2 channels | 2 channels |
| Comparator | | 2 channels | 2 channels |
| Serial interface | | [80-pin, 100-pin products] <ul style="list-style-type: none"> • CSI: 2 channels/UART (UART supporting LIN-bus): 1 channel/simplified I²C: 2 channels • CSI: 2 channels/UART: 1 channel/simplified I²C: 2 channels • CSI: 2 channels/UART: 1 channel/simplified I²C: 2 channels • CSI: 2 channels/UART: 1 channel/simplified I²C: 2 channels | |
| | I ² C bus | 2 channels | 2 channels |
| Data transfer controller (DTC) | | 39 sources | 39 sources |
| Event link controller (ELC) | | Event input: 26 Event trigger output: 9 | |
| Vectored interrupt sources | Internal | 32 | 32 |
| | External | 13 | 13 |
| Key interrupt | | 8 | 8 |
| Reset | | <ul style="list-style-type: none"> • Reset by $\overline{\text{RESET}}$ pin • Internal reset by watchdog timer • Internal reset by power-on-reset • Internal reset by voltage detector • Internal reset by illegal instruction execution ^{Note} • Internal reset by RAM parity error • Internal reset by illegal-memory access | |
| Power-on-reset circuit | | <ul style="list-style-type: none"> • Power-on-reset: 1.51 ±0.04 V (T_A = -40 to +85°C) 1.51 ±0.06 V (T_A = -40 to +105°C) • Power-down-reset: 1.50 ±0.04 V (T_A = -40 to +85°C) 1.50 ±0.06 V (T_A = -40 to +105°C) | |
| Voltage detector | | 1.63 V to 4.06 V (14 stages) | |
| On-chip debug function | | Provided | |
| Power supply voltage | | V _{DD} = 1.6 to 5.5 V (T _A = -40 to +85°C) V _{DD} = 2.4 to 5.5 V (T _A = -40 to +105°C) | |
| Operating ambient temperature | | T _A = -40 to +85°C (A: Consumer applications, D: Industrial applications), T _A = -40 to +105°C (G: Industrial applications) | |

Note The illegal instruction is generated when instruction code FFH is executed.
Reset by the illegal instruction execution is not issued by emulation with the in-circuit emulator or on-chip debug emulator.

2.3 DC Characteristics

2.3.1 Pin characteristics

(TA = -40 to +85°C, 1.6 V ≤ EVDD0 = EVDD1 ≤ VDD ≤ 5.5 V, VSS = EVSS0 = EVSS1 = 0 V)

| Items | Symbol | Conditions | MIN. | TYP. | MAX. | Unit |
|--|--------|---|-----------------------|------|-----------------------------|------|
| Output current, high ^{Note 1} | IOH1 | Per pin for P00 to P06, P10 to P17, P30, P31, P40 to P47, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P100 to P102, P110, P111, P120, P130, P140 to P147 | 1.6 V ≤ EVDD0 ≤ 5.5 V | | -10.0 ^{Note 2} | mA |
| | | Total of P00 to P04, P40 to P47, P102, P120, P130, P140 to P145 (When duty ≤ 70% ^{Note 3}) | 4.0 V ≤ EVDD0 ≤ 5.5 V | | -55.0 | mA |
| | | | 2.7 V ≤ EVDD0 < 4.0 V | | -10.0 | mA |
| | | | 1.8 V ≤ EVDD0 < 2.7 V | | -5.0 | mA |
| | | | 1.6 V ≤ EVDD0 < 1.8 V | | -2.5 | mA |
| | | Total of P05, P06, P10 to P17, P30, P31, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P100, P101, P110, P111, P146, P147 (When duty ≤ 70% ^{Note 3}) | 4.0 V ≤ EVDD0 ≤ 5.5 V | | -80.0 | mA |
| | | | 2.7 V ≤ EVDD0 < 4.0 V | | -19.0 | mA |
| | | | 1.8 V ≤ EVDD0 < 2.7 V | | -10.0 | mA |
| | | | 1.6 V ≤ EVDD0 < 1.8 V | | -5.0 | mA |
| | | Total of all pins (When duty ≤ 70% ^{Note 3}) | 1.6 V ≤ EVDD0 ≤ 5.5 V | | -135.0 ^{Note 4} | mA |
| | IOH2 | Per pin for P20 to P27, P150 to P156 | 1.6 V ≤ VDD ≤ 5.5 V | | -0.1 ^{Note 2} | mA |
| | | Total of all pins (When duty ≤ 70% ^{Note 3}) | 1.6 V ≤ VDD ≤ 5.5 V | | -1.5 | mA |

Note 1. Value of current at which the device operation is guaranteed even if the current flows from the EVDD0, EVDD1, VDD pins to an output pin.

Note 2. Do not exceed the total current value.

Note 3. Specification under conditions where the duty factor ≤ 70%.

The output current value that has changed to the duty factor > 70% the duty ratio can be calculated with the following expression (when changing the duty factor from 70% to n%).

- Total output current of pins = (IOH × 0.7)/(n × 0.01)
 <Example> Where n = 80% and IOH = -10.0 mA
 Total output current of pins = (-10.0 × 0.7)/(80 × 0.01) ≈ -8.7 mA

However, the current that is allowed to flow into one pin does not vary depending on the duty factor.

A current higher than the absolute maximum rating must not flow into one pin.

Note 4. -100 mA for industrial applications (R5F104xxDxx, R5F104xxGxx).

Caution P00, P02 to P04, P10, P11, P13 to P15, P17, P30, P43 to P45, P50 to P55, P71, P74, P80 to P82, and P142 to P144 do not output high level in N-ch open-drain mode.

Remark Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.

(TA = -40 to +85°C, 1.6 V ≤ EVDD0 = EVDD1 ≤ VDD ≤ 5.5 V, VSS = EVSS0 = EVSS1 = 0 V)

(2/5)

| Items | Symbol | Conditions | MIN. | TYP. | MAX. | Unit |
|----------------------------|--------|---|-----------------------|------|----------------|------|
| Output current, low Note 1 | IOL1 | Per pin for P00 to P06, P10 to P17, P30, P31, P40 to P47, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P100 to P102, P110, P111, P120, P130, P140 to P147 | | | 20.0 Note 2 | mA |
| | | Per pin for P60 to P63 | | | 15.0 Note 2 | mA |
| | | Total of P00 to P04, P40 to P47, P102, P120, P130, P140 to P145 (When duty ≤ 70% Note 3) | 4.0 V ≤ EVDD0 ≤ 5.5 V | | 70.0 | mA |
| | | | 2.7 V ≤ EVDD0 < 4.0 V | | 15.0 | mA |
| | | | 1.8 V ≤ EVDD0 < 2.7 V | | 9.0 | mA |
| | | | 1.6 V ≤ EVDD0 < 1.8 V | | 4.5 | mA |
| | | Total of P05, P06, P10 to P17, P30, P31, P50 to P57, P60 to P67, P70 to P77, P80 to P87, P100, P101, P110, P111, P146, P147 (When duty ≤ 70% Note 3) | 4.0 V ≤ EVDD0 ≤ 5.5 V | | 80.0 | mA |
| | | | 2.7 V ≤ EVDD0 < 4.0 V | | 35.0 | mA |
| | | | 1.8 V ≤ EVDD0 < 2.7 V | | 20.0 | mA |
| | | | 1.6 V ≤ EVDD0 < 1.8 V | | 10.0 | mA |
| | | Total of all pins (When duty ≤ 70% Note 3) | | | 150.0 | mA |
| | IOL2 | Per pin for P20 to P27, P150 to P156 | | | 0.4 Note 2 | mA |
| | | Total of all pins (When duty ≤ 70% Note 3) | 1.6 V ≤ VDD ≤ 5.5 V | | 5.0 | mA |

Note 1. Value of current at which the device operation is guaranteed even if the current flows from an output pin to the EVSS0, EVSS1, and VSS pins.

Note 2. Do not exceed the total current value.

Note 3. Specification under conditions where the duty factor ≤ 70%.

The output current value that has changed to the duty factor > 70% the duty ratio can be calculated with the following expression (when changing the duty factor from 70% to n%).

- Total output current of pins = (IOL × 0.7)/(n × 0.01)

<Example> Where n = 80% and IOL = 10.0 mA

$$\text{Total output current of pins} = (10.0 \times 0.7)/(80 \times 0.01) \approx 8.7 \text{ mA}$$

However, the current that is allowed to flow into one pin does not vary depending on the duty factor.

A current higher than the absolute maximum rating must not flow into one pin.

Remark Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.

(2) Flash ROM: 96 to 256 KB of 30- to 100-pin products

(TA = -40 to +85°C, 1.6 V ≤ EVDD0 = EVDD1 ≤ VDD ≤ 5.5 V, VSS = EVSS0 = EVSS1 = 0 V)

(2/2)

| Parameter | Symbol | Conditions | | | | MIN. | TYP. | MAX. | Unit | | | |
|--------------------------|---------------------|---------------------|--|---|--|--|----------------------|------|------|------|------|----|
| Supply current Note 1 | IDD2 Note 2 | HALT mode Note 7 | HS (high-speed main) mode Note 7 | fHOCO = 64 MHz, fIH = 32 MHz Note 4 | VDD = 5.0 V | | 0.79 | 3.32 | mA | | | |
| | | | | | VDD = 3.0 V | | 0.79 | 3.32 | | | | |
| | | | | fHOCO = 32 MHz, fIH = 32 MHz Note 4 | VDD = 5.0 V | | 0.49 | 2.63 | | | | |
| | | | | | VDD = 3.0 V | | 0.49 | 2.63 | | | | |
| | | | | fHOCO = 48 MHz, fIH = 24 MHz Note 4 | VDD = 5.0 V | | 0.62 | 2.57 | | | | |
| | | | | | VDD = 3.0 V | | 0.62 | 2.57 | | | | |
| | | | | fHOCO = 24 MHz, fIH = 24 MHz Note 4 | VDD = 5.0 V | | 0.4 | 2.00 | | | | |
| | | | | | VDD = 3.0 V | | 0.4 | 2.00 | | | | |
| | | | | fHOCO = 16 MHz, fIH = 16 MHz Note 4 | VDD = 5.0 V | | 0.38 | 1.49 | | | | |
| | | | | | VDD = 3.0 V | | 0.38 | 1.49 | | | | |
| | | | LS (low-speed main) mode Note 7 | fHOCO = 8 MHz, fIH = 8 MHz Note 4 | VDD = 3.0 V | | 250 | 800 | μA | | | |
| | | | | | VDD = 2.0 V | | 250 | 800 | | | | |
| | | | LV (low-voltage main) mode Note 7 | fHOCO = 4 MHz, fIH = 4 MHz Note 4 | VDD = 3.0 V | | 420 | 755 | μA | | | |
| | | | | | VDD = 2.0 V | | 420 | 755 | | | | |
| | | | HS (high-speed main) mode Note 7 | fMX = 20 MHz Note 3, VDD = 5.0 V | Square wave input | | 0.30 | 1.63 | mA | | | |
| | | | | | | Resonator connection | | 0.40 | | 1.85 | | |
| | | | | | Square wave input | | 0.30 | 1.63 | | | | |
| | | | | | | Resonator connection | | 0.40 | | 1.85 | | |
| | | | | | fMX = 10 MHz Note 3, VDD = 5.0 V | Square wave input | | 0.20 | | 0.89 | | |
| | | | | | | | Resonator connection | | | 0.25 | 0.97 | |
| | | | | | fMX = 10 MHz Note 3, VDD = 3.0 V | Square wave input | | 0.20 | | 0.89 | | |
| | | | | | | | Resonator connection | | | 0.25 | 0.97 | |
| | | | | | LS (low-speed main) mode Note 7 | fMX = 8 MHz Note 3, VDD = 3.0 V | Square wave input | | | 110 | 580 | μA |
| | | | | | | | Resonator connection | | | 140 | 630 | |
| | | | | | | fMX = 8 MHz Note 3, VDD = 2.0 V | Square wave input | | | 110 | 580 | |
| | | | | | | | Resonator connection | | | 140 | 630 | |
| | | | | | Subsystem clock oper- ation | fSUB = 32.768 kHz Note 5, TA = -40°C | Square wave input | | | 0.28 | 0.66 | μA |
| | | | | | | | Resonator connection | | | 0.47 | 0.85 | |
| | | | fSUB = 32.768 kHz Note 5, TA = +25°C | Square wave input | | | 0.34 | 0.66 | | | | |
| | | | | Resonator connection | | | 0.53 | 0.85 | | | | |
| | | | fSUB = 32.768 kHz Note 5, TA = +50°C | Square wave input | | | 0.37 | 2.35 | | | | |
| | | | | Resonator connection | | | 0.56 | 2.54 | | | | |
| | | | fSUB = 32.768 kHz Note 5, TA = +70°C | Square wave input | | | 0.61 | 4.08 | | | | |
| | | | | Resonator connection | | | 0.80 | 4.27 | | | | |
| | | | fSUB = 32.768 kHz Note 5, TA = +85°C | Square wave input | | | 1.55 | 8.09 | | | | |
| | | | | Resonator connection | | | 1.74 | 8.28 | | | | |
| IDD3 Note 6 | STOP mode Note 8 | TA = -40°C | | | | | 0.19 | 0.57 | μA | | | |
| | | TA = +25°C | | | | | 0.25 | 0.57 | | | | |
| | | TA = +50°C | | | | | 0.33 | 2.26 | | | | |
| | | TA = +70°C | | | | | 0.52 | 3.99 | | | | |
| | | TA = +85°C | | | | | 1.46 | 8.00 | | | | |

(Notes and Remarks are listed on the next page.)

(5) During communication at same potential (simplified I²C mode)**(TA = -40 to +85°C, 1.6 V ≤ EVDD0 = EVDD1 ≤ VDD ≤ 5.5 V, VSS = EVSS0 = EVSS1 = 0 V)**

| Parameter | Symbol | Conditions | HS (high-speed main) mode | | LS (low-speed main) mode | | LV (low-voltage main) mode | | Unit |
|------------------------------|-------------------|---|---------------------------|-------------|--------------------------|------------|----------------------------|------------|------|
| | | | MIN. | MAX. | MIN. | MAX. | MIN. | MAX. | |
| SCLr clock frequency | f _{SCL} | 2.7 V ≤ EVDD0 ≤ 5.5 V, Cb = 50 pF, Rb = 2.7 kΩ | | 1000 Note 1 | | 400 Note 1 | | 400 Note 1 | kHz |
| | | 1.8 V ≤ EVDD0 ≤ 5.5 V, Cb = 100 pF, Rb = 3 kΩ | | 400 Note 1 | | 400 Note 1 | | 400 Note 1 | kHz |
| | | 1.8 V ≤ EVDD0 < 2.7 V, Cb = 100 pF, Rb = 5 kΩ | | 300 Note 1 | | 300 Note 1 | | 300 Note 1 | kHz |
| | | 1.7 V ≤ EVDD0 < 1.8 V, Cb = 100 pF, Rb = 5 kΩ | | 250 Note 1 | | 250 Note 1 | | 250 Note 1 | kHz |
| | | 1.6 V ≤ EVDD0 < 1.8 V, Cb = 100 pF, Rb = 5 kΩ | | — | | 250 Note 1 | | 250 Note 1 | kHz |
| Hold time when SCLr = "L" | t _{LOW} | 2.7 V ≤ EVDD0 ≤ 5.5 V, Cb = 50 pF, Rb = 2.7 kΩ | 475 | | 1150 | | 1150 | | ns |
| | | 1.8 V ≤ EVDD0 ≤ 5.5 V, Cb = 100 pF, Rb = 3 kΩ | 1150 | | 1150 | | 1150 | | ns |
| | | 1.8 V ≤ EVDD0 < 2.7 V, Cb = 100 pF, Rb = 5 kΩ | 1550 | | 1550 | | 1550 | | ns |
| | | 1.7 V ≤ EVDD0 < 1.8 V, Cb = 100 pF, Rb = 5 kΩ | 1850 | | 1850 | | 1850 | | ns |
| | | 1.6 V ≤ EVDD0 < 1.8 V, Cb = 100 pF, Rb = 5 kΩ | — | | 1850 | | 1850 | | ns |
| Hold time when SCLr = "H" | t _{HIGH} | 2.7 V ≤ EVDD0 ≤ 5.5 V, Cb = 50 pF, Rb = 2.7 kΩ | 475 | | 1150 | | 1150 | | ns |
| | | 1.8 V ≤ EVDD0 ≤ 5.5 V, Cb = 100 pF, Rb = 3 kΩ | 1150 | | 1150 | | 1150 | | ns |
| | | 1.8 V ≤ EVDD0 < 2.7 V, Cb = 100 pF, Rb = 5 kΩ | 1550 | | 1550 | | 1550 | | ns |
| | | 1.7 V ≤ EVDD0 < 1.8 V, Cb = 100 pF, Rb = 5 kΩ | 1850 | | 1850 | | 1850 | | ns |
| | | 1.6 V ≤ EVDD0 < 1.8 V, Cb = 100 pF, Rb = 5 kΩ | — | | 1850 | | 1850 | | ns |

(Notes and Caution are listed on the next page, and Remarks are listed on the page after the next page.)

(2) Interrupt & Reset Mode**(TA = -40 to +85°C, VPDR ≤ VDD ≤ 5.5 V, VSS = 0 V)**

| Parameter | Symbol | Conditions | | MIN. | TYP. | MAX. | Unit |
|-----------------------------|--------|--|------------------------------|------|------|------|------|
| Voltage detection threshold | VLVDA0 | VPOC2, VPOC1, VPOC0 = 0, 0, 0, falling reset voltage | | 1.60 | 1.63 | 1.66 | V |
| | VLVDA1 | LVIS1, LVIS0 = 1, 0 | Rising release reset voltage | 1.74 | 1.77 | 1.81 | V |
| | | | Falling interrupt voltage | 1.70 | 1.73 | 1.77 | V |
| | VLVDA2 | LVIS1, LVIS0 = 0, 1 | Rising release reset voltage | 1.84 | 1.88 | 1.91 | V |
| | | | Falling interrupt voltage | 1.80 | 1.84 | 1.87 | V |
| | VLVDA3 | LVIS1, LVIS0 = 0, 0 | Rising release reset voltage | 2.86 | 2.92 | 2.97 | V |
| | | | Falling interrupt voltage | 2.80 | 2.86 | 2.91 | V |
| | VLVDB0 | VPOC2, VPOC1, VPOC0 = 0, 0, 1, falling reset voltage | | 1.80 | 1.84 | 1.87 | V |
| | VLVDB1 | LVIS1, LVIS0 = 1, 0 | Rising release reset voltage | 1.94 | 1.98 | 2.02 | V |
| | | | Falling interrupt voltage | 1.90 | 1.94 | 1.98 | V |
| | VLVDB2 | LVIS1, LVIS0 = 0, 1 | Rising release reset voltage | 2.05 | 2.09 | 2.13 | V |
| | | | Falling interrupt voltage | 2.00 | 2.04 | 2.08 | V |
| | VLVDB3 | LVIS1, LVIS0 = 0, 0 | Rising release reset voltage | 3.07 | 3.13 | 3.19 | V |
| | | | Falling interrupt voltage | 3.00 | 3.06 | 3.12 | V |
| | VLVDC0 | VPOC2, VPOC1, VPOC0 = 0, 1, 0, falling reset voltage | | 2.40 | 2.45 | 2.50 | V |
| | VLVDC1 | LVIS1, LVIS0 = 1, 0 | Rising release reset voltage | 2.56 | 2.61 | 2.66 | V |
| | | | Falling interrupt voltage | 2.50 | 2.55 | 2.60 | V |
| | VLVDC2 | LVIS1, LVIS0 = 0, 1 | Rising release reset voltage | 2.66 | 2.71 | 2.76 | V |
| | | | Falling interrupt voltage | 2.60 | 2.65 | 2.70 | V |
| | VLVDC3 | LVIS1, LVIS0 = 0, 0 | Rising release reset voltage | 3.68 | 3.75 | 3.82 | V |
| | | | Falling interrupt voltage | 3.60 | 3.67 | 3.74 | V |
| | VLVDD0 | VPOC2, VPOC1, VPOC0 = 0, 1, 1, falling reset voltage | | 2.70 | 2.75 | 2.81 | V |
| | VLVDD1 | LVIS1, LVIS0 = 1, 0 | Rising release reset voltage | 2.86 | 2.92 | 2.97 | V |
| | | | Falling interrupt voltage | 2.80 | 2.86 | 2.91 | V |
| | VLVDD2 | LVIS1, LVIS0 = 0, 1 | Rising release reset voltage | 2.96 | 3.02 | 3.08 | V |
| | | | Falling interrupt voltage | 2.90 | 2.96 | 3.02 | V |
| | VLVDD3 | LVIS1, LVIS0 = 0, 0 | Rising release reset voltage | 3.98 | 4.06 | 4.14 | V |
| | | | Falling interrupt voltage | 3.90 | 3.98 | 4.06 | V |

2.6.7 Power supply voltage rising slope characteristics**(TA = -40 to +85°C, VSS = 0 V)**

| Parameter | Symbol | Conditions | MIN. | TYP. | MAX. | Unit |
|-----------------------------------|--------|------------|------|------|------|------|
| Power supply voltage rising slope | SVDD | | | | 54 | V/ms |

Caution Make sure to keep the internal reset state by the LVD circuit or an external reset until VDD reaches the operating voltage range shown in 2.4 AC Characteristics.

Operation of products rated “G: Industrial applications (TA = -40 to + 105°C)” at ambient operating temperatures above 85°C differs from that of products rated “A: Consumer applications” and “D: Industrial applications” in the ways listed below.

| Parameter | A: Consumer applications, D: Industrial applications | G: Industrial applications |
|--|--|---|
| Operating ambient temperature | TA = -40 to +85°C | TA = -40 to +105°C |
| Operating mode Operating voltage range | HS (high-speed main) mode: $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}@1\text{ MHz to }32\text{ MHz}$ $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}@1\text{ MHz to }16\text{ MHz}$ LS (low-speed main) mode: $1.8\text{ V} \leq V_{DD} \leq 5.5\text{ V}@1\text{ MHz to }8\text{ MHz}$ LV (low-voltage main) mode: $1.6\text{ V} \leq V_{DD} \leq 5.5\text{ V}@1\text{ MHz to }4\text{ MHz}$ | HS (high-speed main) mode only: $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}@1\text{ MHz to }32\text{ MHz}$ $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}@1\text{ MHz to }16\text{ MHz}$ |
| High-speed on-chip oscillator clock accuracy | $1.8\text{ V} \leq V_{DD} \leq 5.5\text{ V}$: $\pm 1.0\%$ @ TA = -20 to +85°C $\pm 1.5\%$ @ TA = -40 to -20°C $1.6\text{ V} \leq V_{DD} < 1.8\text{ V}$: $\pm 5.0\%$ @ TA = -20 to +85°C $\pm 5.5\%$ @ TA = -40 to -20°C | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$: $\pm 2.0\%$ @ TA = +85 to +105°C $\pm 1.0\%$ @ TA = -20 to +85°C $\pm 1.5\%$ @ TA = -40 to -20°C |
| Serial array unit | UART CSI: fCLK/2 (16 Mbps supported), fCLK/4 Simplified I ² C communication | UART CSI: fCLK/4 Simplified I ² C communication |
| IICA | Standard mode Fast mode Fast mode plus | Standard mode Fast mode |
| Voltage detector | <ul style="list-style-type: none"> Rising: 1.67 V to 4.06 V (14 stages) Falling: 1.63 V to 3.98 V (14 stages) | <ul style="list-style-type: none"> Rising: 2.61 V to 4.06 V (8 stages) Falling: 2.55 V to 3.98 V (8 stages) |

Remark The electrical characteristics of products rated “G: Industrial applications (TA = -40 to + 105°C)” at ambient operating temperatures above 85°C differ from those of products rated “A: Consumer applications” and “D: Industrial applications”. For details, refer to 3.1 to 3.10.

3.3 DC Characteristics

3.3.1 Pin characteristics

(TA = -40 to +105°C, 2.4 V ≤ EVDD0 = EVDD1 ≤ VDD ≤ 5.5 V, VSS = EVSS0 = EVSS1 = 0 V)

| Items | Symbol | Conditions | MIN. | TYP. | MAX. | Unit |
|--|--------|---|-----------------------|------|---------------------------|------|
| Output current, high ^{Note 1} | IOH1 | Per pin for P00 to P06, P10 to P17, P30, P31, P40 to P47, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P100 to P102, P110, P111, P120, P130, P140 to P147 | 2.4 V ≤ EVDD0 ≤ 5.5 V | | -3.0 ^{Note 2} | mA |
| | | Total of P00 to P04, P40 to P47, P102, P120, P130, P140 to P145 (When duty ≤ 70% ^{Note 3}) | 4.0 V ≤ EVDD0 ≤ 5.5 V | | -30.0 | mA |
| | | | 2.7 V ≤ EVDD0 < 4.0 V | | -10.0 | mA |
| | | | 2.4 V ≤ EVDD0 < 2.7 V | | -5.0 | mA |
| | | Total of P05, P06, P10 to P17, P30, P31, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P100, P101, P110, P111, P146, P147 (When duty ≤ 70% ^{Note 3}) | 4.0 V ≤ EVDD0 ≤ 5.5 V | | -30.0 | mA |
| | | | 2.7 V ≤ EVDD0 < 4.0 V | | -19.0 | mA |
| | | | 2.4 V ≤ EVDD0 < 2.7 V | | -10.0 | mA |
| | | Total of all pins (When duty ≤ 70% ^{Note 3}) | 2.4 V ≤ EVDD0 ≤ 5.5 V | | -60.0 | mA |
| | IOH2 | Per pin for P20 to P27, P150 to P156 | 2.4 V ≤ VDD ≤ 5.5 V | | -0.1 ^{Note 2} | mA |
| | | Total of all pins (When duty ≤ 70% ^{Note 3}) | 2.4 V ≤ VDD ≤ 5.5 V | | -1.5 | mA |

Note 1. Value of current at which the device operation is guaranteed even if the current flows from the EVDD0, EVDD1, VDD pins to an output pin.

Note 2. Do not exceed the total current value.

Note 3. Specification under conditions where the duty factor ≤ 70%.

The output current value that has changed to the duty factor > 70% the duty ratio can be calculated with the following expression (when changing the duty factor from 70% to n%).

- Total output current of pins = (IOH × 0.7)/(n × 0.01)
 <Example> Where n = 80% and IOH = -10.0 mA
 Total output current of pins = (-10.0 × 0.7)/(80 × 0.01) ≈ -8.7 mA

However, the current that is allowed to flow into one pin does not vary depending on the duty factor.

A current higher than the absolute maximum rating must not flow into one pin.

Caution P00, P02 to P04, P10, P11, P13 to P15, P17, P30, P43 to P45, P50 to P55, P71, P74, P80 to P82, and P142 to P144 do not output high level in N-ch open-drain mode.

Remark Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.

(2) Flash ROM: 96 to 256 KB of 30- to 100-pin products

(TA = -40 to +105°C, 2.4 V ≤ EVDD0 = EVDD1 ≤ VDD ≤ 5.5 V, VSS = EVSS0 = EVSS1 = 0 V)

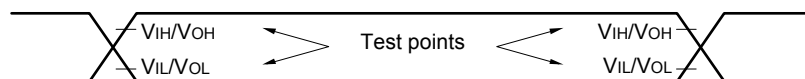
(2/2)

| Parameter | Symbol | Conditions | | | | MIN. | TYP. | MAX. | Unit | |
|--------------------------|----------------|--------------------------------|--|---|----------------------|------|------|-------|-------|----|
| Supply current Note 1 | IDD2 Note 2 | HALT mode | HS (high-speed main) mode Note 7 | fHOCO = 64 MHz, fIH = 32 MHz Note 4 | VDD = 5.0 V | | 0.79 | 4.86 | mA | |
| | | | | VDD = 3.0 V | | | 0.79 | 4.86 | | |
| | | | | fHOCO = 32 MHz, fIH = 32 MHz Note 4 | VDD = 5.0 V | | 0.49 | 4.17 | | |
| | | | | VDD = 3.0 V | | | 0.49 | 4.17 | | |
| | | | | fHOCO = 48 MHz, fIH = 24 MHz Note 4 | VDD = 5.0 V | | 0.62 | 3.82 | | |
| | | | | VDD = 3.0 V | | | 0.62 | 3.82 | | |
| | | | | fHOCO = 24 MHz, fIH = 24 MHz Note 4 | VDD = 5.0 V | | 0.4 | 3.25 | | |
| | | | | VDD = 3.0 V | | | 0.4 | 3.25 | | |
| | | | | fHOCO = 16 MHz, fIH = 16 MHz Note 4 | VDD = 5.0 V | | 0.38 | 2.28 | | |
| | | | | VDD = 3.0 V | | | 0.38 | 2.28 | | |
| | | | HS (high-speed main) mode Note 7 | fMX = 20 MHz Note 3, VDD = 5.0 V | Square wave input | | 0.30 | 2.65 | mA | |
| | | | | | Resonator connection | | 0.40 | 2.77 | | |
| | | | | fMX = 20 MHz Note 3, VDD = 3.0 V | Square wave input | | 0.30 | 2.65 | | |
| | | | | | Resonator connection | | 0.40 | 2.77 | | |
| | | | | fMX = 10 MHz Note 3, VDD = 5.0 V | Square wave input | | 0.20 | 1.36 | | |
| | | | | | Resonator connection | | 0.25 | 1.46 | | |
| | | | | fMX = 10 MHz Note 3, VDD = 3.0 V | Square wave input | | 0.20 | 1.36 | | |
| | | | | | Resonator connection | | 0.25 | 1.46 | | |
| | | Subsystem clock oper- ation | | fSUB = 32.768 kHz Note 5, TA = -40°C | Square wave input | | 0.28 | 0.66 | μA | |
| | | | | | Resonator connection | | 0.47 | 0.85 | | |
| | | | | fSUB = 32.768 kHz Note 5, TA = +25°C | Square wave input | | 0.34 | 0.66 | | |
| | | | | | Resonator connection | | 0.53 | 0.85 | | |
| | | | | fSUB = 32.768 kHz Note 5, TA = +50°C | Square wave input | | 0.37 | 2.35 | | |
| | | | | | Resonator connection | | 0.56 | 2.54 | | |
| | | | | fSUB = 32.768 kHz Note 5, TA = +70°C | Square wave input | | 0.61 | 4.08 | | |
| | | | | | Resonator connection | | 0.80 | 4.27 | | |
| | | | | fSUB = 32.768 kHz Note 5, TA = +85°C | Square wave input | | 1.55 | 8.09 | | |
| | | | | | Resonator connection | | 1.74 | 8.28 | | |
| | | | | fSUB = 32.768 kHz Note 5, TA = +105°C | Square wave input | | 6.00 | 51.00 | | |
| | | | | | Resonator connection | | 6.00 | 51.00 | | |
| | IDD3 Note 6 | STOP mode Note 8 | TA = -40°C | | | | | 0.19 | 0.57 | μA |
| | | | TA = +25°C | | | | | 0.25 | 0.57 | |
| | | | TA = +50°C | | | | | 0.33 | 2.26 | |
| | | | TA = +70°C | | | | | 0.52 | 3.99 | |
| | | | TA = +85°C | | | | | 1.46 | 8.00 | |
| | | | TA = +105°C | | | | | 5.50 | 50.00 | |

(Notes and Remarks are listed on the next page.)

3.5 Peripheral Functions Characteristics

AC Timing Test Points



3.5.1 Serial array unit

(1) During communication at same potential (UART mode)

($T_A = -40$ to $+105^\circ\text{C}$, $2.4\text{ V} \leq \text{EVDD0} = \text{EVDD1} \leq 5.5\text{ V}$, $\text{Vss} = \text{EVss0} = \text{EVss1} = 0\text{ V}$)

| Parameter | Symbol | Conditions | HS (high-speed main) Mode | | Unit |
|----------------------|--------|--|---------------------------|----------------------------|------|
| | | | MIN. | MAX. | |
| Transfer rate Note 1 | | $2.4\text{ V} \leq \text{EVDD0} \leq 5.5\text{ V}$ | | $f_{\text{MCK}}/12$ Note 2 | bps |
| | | Theoretical value of the maximum transfer rate $f_{\text{MCK}} = f_{\text{CLK}}$ Note 3 | | 2.6 | Mbps |

Note 1. Transfer rate in the SNOOZE mode is 4800 bps only.

However, the SNOOZE mode cannot be used when $\text{FRQSEL4} = 1$.

Note 2. The following conditions are required for low voltage interface when $\text{EVDD0} < \text{VDD}$.

$2.4\text{ V} \leq \text{EVDD0} < 2.7\text{ V}$: MAX. 1.3 Mbps

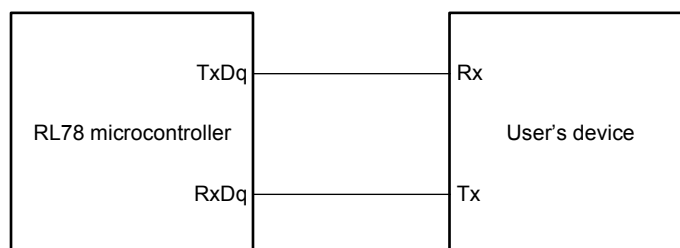
Note 3. The maximum operating frequencies of the CPU/peripheral hardware clock (f_{CLK}) are:

HS (high-speed main) mode: 32 MHz ($2.7\text{ V} \leq \text{VDD} \leq 5.5\text{ V}$)

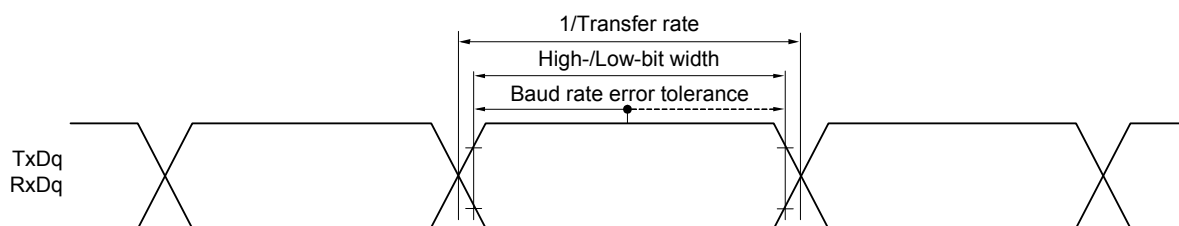
16 MHz ($2.4\text{ V} \leq \text{VDD} \leq 5.5\text{ V}$)

Caution Select the normal input buffer for the RxDq pin and the normal output mode for the TxDq pin by using port input mode register g (PIMg) and port output mode register g (POMg).

UART mode connection diagram (during communication at same potential)



UART mode bit width (during communication at same potential) (reference)



Remark 1. q: UART number (q = 0 to 3), g: PIM and POM number (g = 0, 1, 5, 14)

Remark 2. f_{MCK} : Serial array unit operation clock frequency

(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn). m: Unit number,

n: Channel number (mn = 00 to 03, 10 to 13))

(5) Communication at different potential (1.8 V, 2.5 V, 3 V) (UART mode)**(TA = -40 to +105°C, 2.4 V ≤ EVDD0 = EVDD1 ≤ VDD ≤ 5.5 V, VSS = EVSS0 = EVSS1 = 0 V)****(2/2)**

| Parameter | Symbol | Conditions | HS (high-speed main) mode | | Unit |
|---------------|--------|--------------|--|-------------|------|
| | | | MIN. | MAX. | |
| Transfer rate | | transmission | 4.0 V ≤ EVDD0 ≤ 5.5 V, 2.7 V ≤ Vb ≤ 4.0 V | Note 1 | bps |
| | | | Theoretical value of the maximum transfer rate Cb = 50 pF, Rb = 1.4 kΩ, Vb = 2.7 V | 2.6 Note 2 | Mbps |
| | | | 2.7 V ≤ EVDD0 < 4.0 V, 2.3 V ≤ Vb ≤ 2.7 V | Note 3 | bps |
| | | | Theoretical value of the maximum transfer rate Cb = 50 pF, Rb = 2.7 kΩ, Vb = 2.3 V | 1.2 Note 4 | Mbps |
| | | | 2.4 V ≤ EVDD0 < 3.3 V, 1.6 V ≤ Vb ≤ 2.0 V | Note 5 | bps |
| | | | Theoretical value of the maximum transfer rate Cb = 50 pF, Rb = 5.5 kΩ, Vb = 1.6 V | 0.43 Note 6 | Mbps |

Note 1. The smaller maximum transfer rate derived by using fmCK/12 or the following expression is the valid maximum transfer rate.

Expression for calculating the transfer rate when 4.0 V ≤ EVDD0 ≤ 5.5 V and 2.7 V ≤ Vb ≤ 4.0 V

$$\text{Maximum transfer rate} = \frac{1}{\{-C_b \times R_b \times \ln(1 - \frac{2.2}{V_b})\} \times 3} \text{ [bps]}$$

$$\text{Baud rate error (theoretical value)} = \frac{\frac{1}{\text{Transfer rate} \times 2} - \{-C_b \times R_b \times \ln(1 - \frac{2.2}{V_b})\}}{(\frac{1}{\text{Transfer rate}}) \times \text{Number of transferred bits}} \times 100 \text{ [%]}$$

* This value is the theoretical value of the relative difference between the transmission and reception sides

Note 2. This value as an example is calculated when the conditions described in the "Conditions" column are met. Refer to **Note 1** above to calculate the maximum transfer rate under conditions of the customer.

Note 3. The smaller maximum transfer rate derived by using fmCK/12 or the following expression is the valid maximum transfer rate.

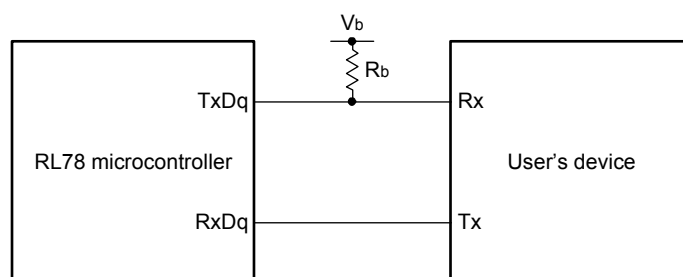
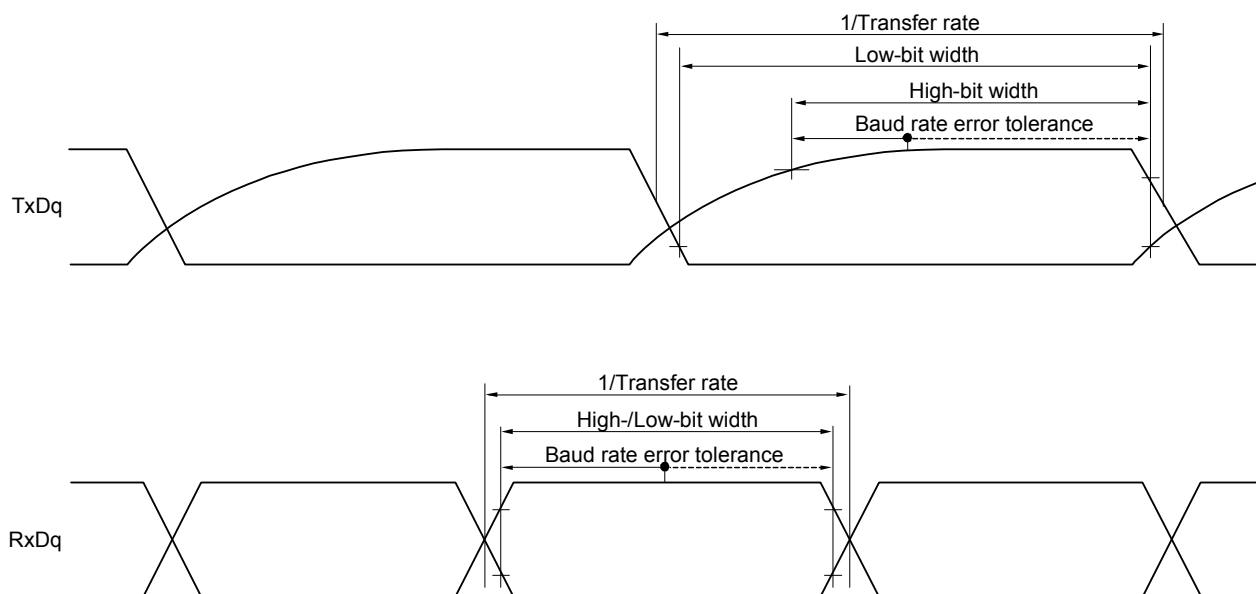
Expression for calculating the transfer rate when 2.7 V ≤ EVDD0 < 4.0 V and 2.3 V ≤ Vb ≤ 2.7 V

$$\text{Maximum transfer rate} = \frac{1}{\{-C_b \times R_b \times \ln(1 - \frac{2.0}{V_b})\} \times 3} \text{ [bps]}$$

$$\text{Baud rate error (theoretical value)} = \frac{\frac{1}{\text{Transfer rate} \times 2} - \{-C_b \times R_b \times \ln(1 - \frac{2.0}{V_b})\}}{(\frac{1}{\text{Transfer rate}}) \times \text{Number of transferred bits}} \times 100 \text{ [%]}$$

* This value is the theoretical value of the relative difference between the transmission and reception sides

Note 4. This value as an example is calculated when the conditions described in the "Conditions" column are met. Refer to **Note 3** above to calculate the maximum transfer rate under conditions of the customer.

UART mode connection diagram (during communication at different potential)**UART mode bit width (during communication at different potential) (reference)**

Remark 1. $R_b[\Omega]$: Communication line (TxDq) pull-up resistance,

$C_b[\text{F}]$: Communication line (TxDq) load capacitance, $V_b[\text{V}]$: Communication line voltage

Remark 2. q: UART number (q = 0 to 3), g: PIM and POM number (g = 0, 1, 5, 14)

Remark 3. f_{MCK} : Serial array unit operation clock frequency

(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn).

m: Unit number, n: Channel number (mn = 00 to 03, 10 to 13))

Remark 4. UART2 cannot communicate at different potential when bit 1 (PIOR01) of peripheral I/O redirection register 0 (PIOR0) is 1.

3.5.2 Serial interface IICA

($T_A = -40$ to $+105^\circ\text{C}$, $2.4\text{ V} \leq \text{EVDD0} = \text{EVDD1} \leq \text{VDD} \leq 5.5\text{ V}$, $\text{VSS} = \text{EVSS0} = \text{EVSS1} = 0\text{ V}$)

| Parameter | Symbol | Conditions | HS (high-speed main) mode | | | | Unit |
|---|----------|-----------------------------|---------------------------|------|-----------|------|------|
| | | | Standard mode | | Fast mode | | |
| | | | MIN. | MAX. | MIN. | MAX. | |
| SCLA0 clock frequency | fSCL | Fast mode: fCLK ≥ 3.5 MHz | — | — | 0 | 400 | kHz |
| | | Standard mode: fCLK ≥ 1 MHz | 0 | 100 | — | — | |
| Setup time of restart condition | tSU: STA | | 4.7 | | 0.6 | | μs |
| Hold time ^{Note 1} | tHD: STA | | 4.0 | | 0.6 | | μs |
| Hold time when SCLA0 = “L” | tLOW | | 4.7 | | 1.3 | | μs |
| Hold time when SCLA0 = “H” | tHIGH | | 4.0 | | 0.6 | | μs |
| Data setup time (reception) | tSU: DAT | | 250 | | 100 | | ns |
| Data hold time (transmission) ^{Note 2} | tHD: DAT | | 0 | 3.45 | 0 | 0.9 | μs |
| Setup time of stop condition | tSU: STO | | 4.0 | | 0.6 | | μs |
| Bus-free time | tBUF | | 4.7 | | 1.3 | | μs |

Note 1. The first clock pulse is generated after this period when the start/restart condition is detected.

Note 2. The maximum value (MAX.) of t_{HD: DAT} is during normal transfer and a wait state is inserted in the ACK (acknowledge) timing.

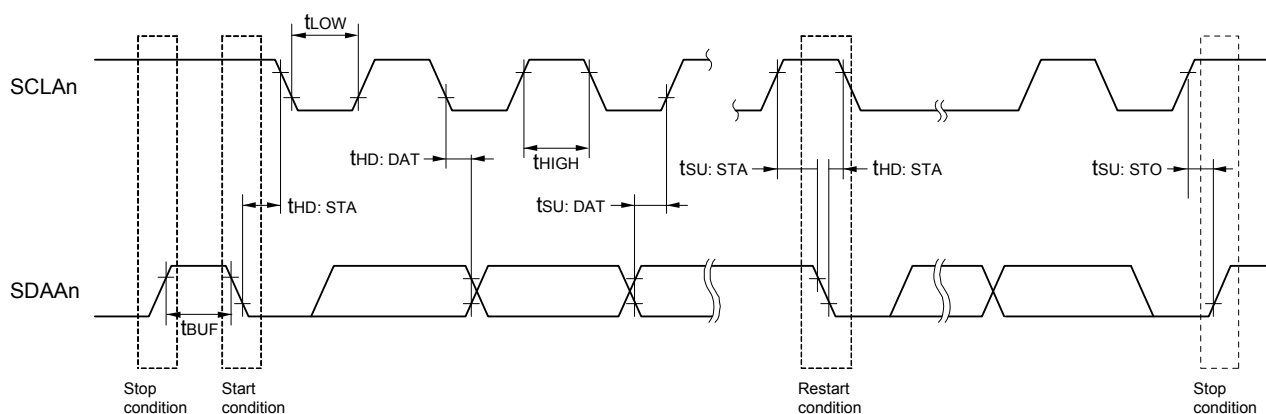
Caution The values in the above table are applied even when bit 2 (PIOR02) in the peripheral I/O redirection register 0 (PIOR0) is 1. At this time, the pin characteristics (IOH1, IOL1, VOH1, VOL1) must satisfy the values in the redirect destination.

Remark The maximum value of C_b (communication line capacitance) and the value of R_b (communication line pull-up resistor) at that time in each mode are as follows.

Standard mode: C_b = 400 pF, R_b = 2.7 kΩ

Fast mode: C_b = 320 pF, R_b = 1.1 kΩ

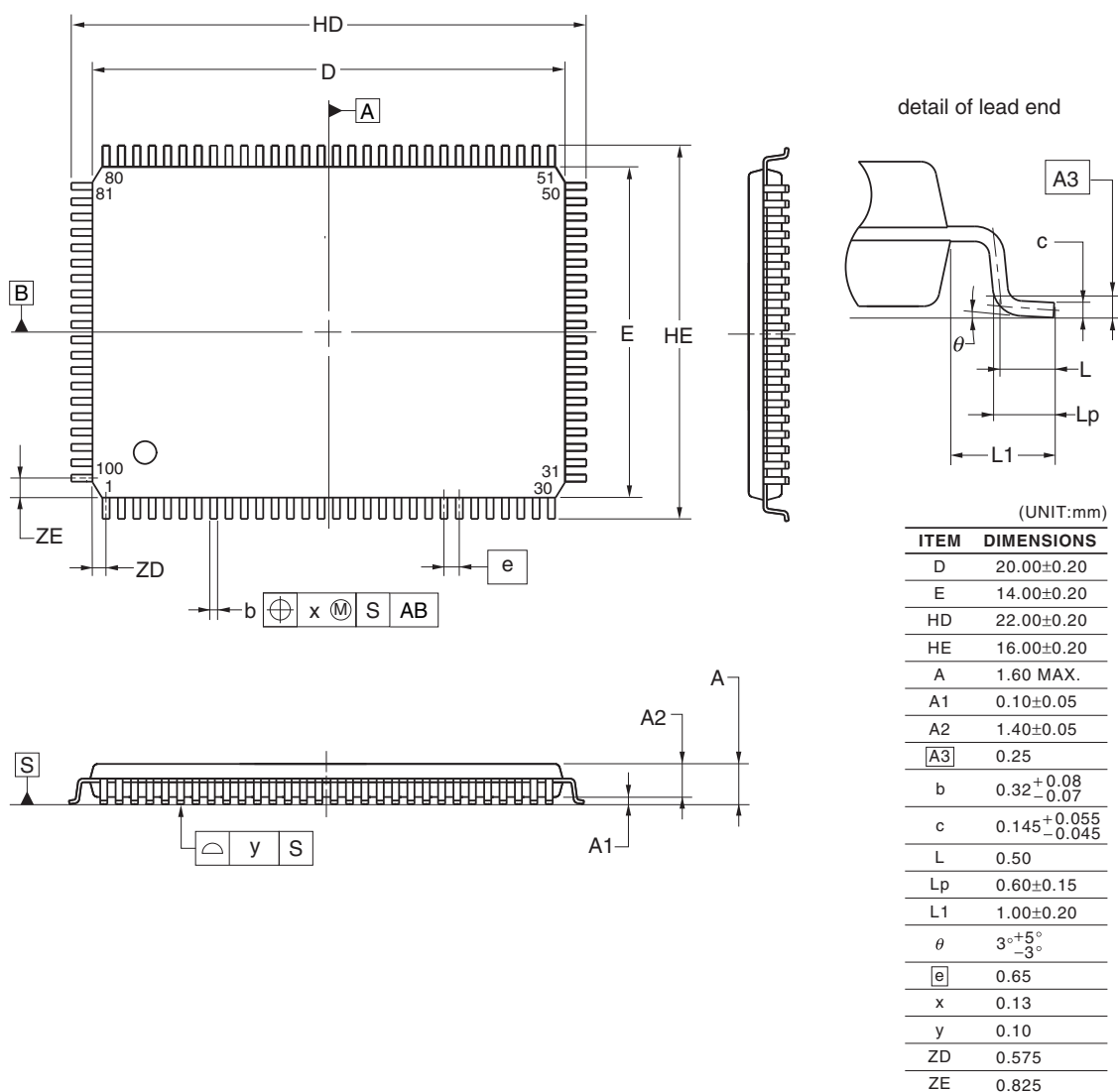
IICA serial transfer timing



Remark n = 0, 1

R5F104PFAFA, R5F104PGAFA, R5F104PHAFA, R5F104PJFAFA
 R5F104PFDFA, R5F104PGDFA, R5F104PHDFA, R5F104PJDFA
 R5F104PFGFA, R5F104PGGFA, R5F104PHGFA, R5F104PJGFA
 R5F104PKAFA, R5F104PLAFA
 R5F104PKGFA, R5F104PLGFA

| JEITA Package Code | RENESAS Code | Previous Code | MASS (TYP.) [g] |
|----------------------|--------------|-----------------|-----------------|
| P-LQFP100-14x20-0.65 | PLQP0100JC-A | P100GF-65-GBN-1 | 0.92 |



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